

演讲申请表

Speaker Application Form

演讲人姓名 Speaker's Name		职务 Job Title
公司名称 Company Name		
公司性质 Company Classification	☐ OEM; ☐ EMS; ☐ PCB Fab; ☐ 材料供应商 Material Supplier; ☐ 设备供应商 Equipment Supplier; ☐ 第三方实验机构 Third Part/Lab; ☐ 器件供应商 Component and Device	
公司简介 Company Introduction		
手机 MP		邮箱 E-mail
演讲人简介 Speaker's Bio (请附演讲人高清照片, Please attach the high resolution pic of speaker)		
演讲主题范围 Primary Topic	☐ 先进封装 Advanced Packing; ☐ 设计 Design; ☐ PCB; ☐ PCBA; ☐ 可持续发展 ESG; ☐ 未来工厂 Factory of the Future; ☐ 人才培养 Talent Cultivation; ☐ 新兴技术 Emerging Technologies; ☐ 高可靠性 High Reliability	
演讲题目 Speech Topic		
演讲摘要 Speech Abstract		
演讲语言种类 Presentation Language	☐ 中文 Chinese ☐ 英语 English 注：大会官方语言为中文，请自行配备翻译或准备双语 PPT，谢谢！ Note: The official language is Chinese. Please make sure your translator will come with you if necessary, and please prepare your paper in CN or bilanguage, thanks!	
演讲 PPT 分享 Sharing PPT	☐ 允许 Allowed ☐ 不允许 Not Allowed 注：请确认是否授权 IPC 分享现场演讲 PPT。 Note: Please confirm that IPC is authorized to share your PPT to attendees.	

注意事项 Notes:

- IPC 将选择使用表格中的内容，公开发布于主办方的网站、会议议程等宣传资料中，请务必确保内容准确无误；
IPC will use the above information to be publicly posted on the official website, conference programme and other promotional materials, so please ensure that the information is accurate.
- 如果内容有任何疑问或疑虑，IPC 保留要求进行更改的权利。
IPC reserves the right to request changes if there are any questions or concerns about the content.